

Global PCB & PCBA Market Status and Outlook 2018-2025

<https://marketpublishers.com/r/G65565B8CF0EN.html>

Date: July 2018

Pages: 248

Price: US\$ 4,000.00 (Single User License)

ID: G65565B8CF0EN

Abstracts

Report Snapshot

Key Content of Chapters (Including and can be customized, report is a semifinished version, and it takes 48-72 hours to upgrade)

Part 1: Terminology Definition, Industry Chain, Industry Dynamics & Regulations and Global Market Overview

Part 2: Upstream (Raw Materials / Components) & Manufacturing (Procurement Methods & Channels and Cost), Major Regional Production Overview and Trade Flow

Part 3: Product Segment Overview and Market Status

Part 4: Application / End-User Segment Overview and Market Status

Part 5: Region Segment Overview and Market Status

Part 6: Product & Application Segment Production & Demand by Region

Part 7: Market Forecast by Product, Application & Region

Part 8: Company information, Products & Services and Business Operation (Sales, Cost, Margin etc.)

Part 9: Market Competition and Environment for New Entrants

Part 10: Conclusion

Market Segment as follows:

Key Companies

Nippon Mektron

Unimicron

SEMCO

Young Poong Group

Ibiden

ZDT

Tripod

TTM

SEI

Daeduck Group

HannStar Board (GBM)

Viasystems

Nanya PCB

CMK Corporation

Shinko Electric Ind

Compeq

AT&S

Kingboard

Ellington

Junda Electronic

CCTC

Redboard

Wuzhou Group

Kinwong

Aoshikang

Shennan Circuits

Market by Type

Rigid 1-2Sided

Standard Multilayer

HDI/Microvia/Build-Up

IC Substrate

Flexible Circuits

Rigid Flex

Others

Market by Application

Consumer electronics

Computer

Communications

Industrial/Medical

Automotive

Military/Aerospace

Others

Contents

PART 1 INDUSTRY OVERVIEW (200 USD)

- 1.1 PCB & PCBA Industry
 - 1.1.1 Market Development
 - 1.1.2 Terminology Definition in the Report
 - 1.1.2.1 Production
 - 1.1.2.2 Demand
 - 1.1.2.3 Sales Revenue
 - 1.1.2.4 Ex-factory Price & Sales Price
 - 1.1.2.5 Cost
 - 1.1.2.6 Gross Margin
- 1.2 Products & Services Scope
- 1.3 Industry Chain
- 1.4 Industry Dynamics & Regulations
- 1.5 Global Market Overview

PART 2 UPSTREAM & PRODUCTION (200 USD)

- 2.1 Raw Materials / Components
- 2.2 Procurement Methods & Channels
- 2.3 Cost Structure & Manufacturing
- 2.4 Industry Capacity
- 2.5 Production Distribution by Geography
 - 2.5.1 Production in Major Regions / Countries
 - 2.5.2 Trade Flow Overview

PART 3 PRODUCT SEGMENT (400 USD)

- 3.1 Introduction by Type
 - 3.1.1 Rigid 1-2Sided
 - 3.1.2 Standard Multilayer
 - 3.1.3 HDI/Microvia/Build-Up
 - 3.1.4 IC Substrate
 - 3.1.5 Flexible Circuits
 - 3.1.6 Rigid Flex
 - 3.1.7 Others
- 3.2 Market Status

PART 4 APPLICATION / END-USER SEGMENT (400 USD)

4.1 Introduction by Application

4.1.1 Consumer electronics

4.1.2 Computer

4.1.3 Communications

4.1.4 Industrial/Medical

4.1.5 Automotive

4.1.6 Military/Aerospace

4.1.7 Others

4.2 Market Status

PART 5 REGIONAL MARKET (600 USD)

5.1 Market Overview

5.2 by Region

5.2.1 North America

5.2.1.1 United States Market Size and Growth (2015-2018E)

5.2.1.2 Canada Market Size and Growth (2015-2018E)

5.2.1.3 Mexico Market Size and Growth (2015-2018E)

5.2.2 Europe

5.2.2.1 Germany Market Size and Growth (2015-2018E)

5.2.2.2 UK Market Size and Growth (2015-2018E)

5.2.2.3 France Market Size and Growth (2015-2018E)

5.2.2.4 Italy Market Size and Growth (2015-2018E)

5.2.2.5 Spain Market Size and Growth (2015-2018E)

5.2.2.6 Netherlands Market Size and Growth (2015-2018E)

5.2.2.7 Poland Market Size and Growth (2015-2018E)

5.2.2.8 Belgium Market Size and Growth (2015-2018E)

5.2.2.9 Sweden Market Size and Growth (2015-2018E)

5.2.2.10 Austria Market Size and Growth (2015-2018E)

5.2.2.11 Denmark Market Size and Growth (2015-2018E)

5.2.2.12 Switzerland Market Size and Growth (2015-2018E)

5.2.2.13 Russia Market Size and Growth (2015-2018E)

5.2.3 Asia-Pacific

5.2.3.1 China Market Size and Growth (2015-2018E)

5.2.3.2 India Market Size and Growth (2015-2018E)

5.2.3.3 Japan Market Size and Growth (2015-2018E)

- 5.2.3.4 Korea Market Size and Growth (2015-2018E)
- 5.2.3.5 Australia Market Size and Growth (2015-2018E)
- 5.2.3.6 Indonesia Market Size and Growth (2015-2018E)
- 5.2.3.7 Thailand Market Size and Growth (2015-2018E)
- 5.2.3.8 Malaysia Market Size and Growth (2015-2018E)
- 5.2.3.9 Singapore Market Size and Growth (2015-2018E)
- 5.2.3.10 Philippines Market Size and Growth (2015-2018E)
- 5.2.4 South America
 - 5.2.4.1 Brazil Market Size and Growth (2015-2018E)
 - 5.2.4.2 Argentina Market Size and Growth (2015-2018E)
 - 5.2.4.3 Columbia Market Size and Growth (2015-2018E)
 - 5.2.4.4 Chile Market Size and Growth (2015-2018E)
 - 5.2.4.5 Peru Market Size and Growth (2015-2018E)
 - 5.2.4.6 Puerto Rico Market Size and Growth (2015-2018E)
 - 5.2.4.7 Ecuador Market Size and Growth (2015-2018E)
- 5.2.5 Middle East
 - 5.2.5.1 Saudi Arabia Market Size and Growth (2015-2018E)
 - 5.2.5.2 Iran Market Size and Growth (2015-2018E)
 - 5.2.5.3 UAE Market Size and Growth (2015-2018E)
 - 5.2.5.4 Oman Market Size and Growth (2015-2018E)
 - 5.2.5.5 Kuwait Market Size and Growth (2015-2018E)
 - 5.2.5.6 Iraq Market Size and Growth (2015-2018E)
 - 5.2.5.7 Turkey Market Size and Growth (2015-2018E)
- 5.2.6 Africa
 - 5.2.6.1 South Africa Market Size and Growth (2015-2018E)
 - 5.2.6.2 Egypt Market Size and Growth (2015-2018E)
 - 5.2.6.3 Nigeria Market Size and Growth (2015-2018E)
 - 5.2.6.4 Algeria Market Size and Growth (2015-2018E)
 - 5.2.6.5 Angola Market Size and Growth (2015-2018E)
 - 5.2.6.6 Morocco Market Size and Growth (2015-2018E)
 - 5.2.6.7 Sultan Market Size and Growth (2015-2018E)

PART 6 MARKET SUBDIVISION (800 USD)

6.1 Regional Production

6.1.1 Production by Type

6.1.1.1 Rigid 1-2Sided Production by Region

6.1.1.2 Standard Multilayer Production by Region

6.1.1.3 HDI/Microvia/Build-Up Production by Region

- 6.1.1.4 IC Substrate Production by Region
- 6.1.1.5 Flexible Circuits Production by Region
- 6.1.1.6 Rigid Flex Production by Region
- 6.1.1.7 Others Production by Region
- 6.1.2 Production by Application
 - 6.1.2.1 Consumer electronics Production by Region
 - 6.1.2.2 Computer Production by Region
 - 6.1.2.3 Communications Production by Region
 - 6.1.2.4 Industrial/Medical Production by Region
 - 6.1.2.5 Automotive Production by Region
 - 6.1.2.6 Military/Aerospace Production by Region
 - 6.1.2.7 Others Production by Region
- 6.2 Regional Demand
 - 6.2.1 Demand by Type
 - 6.2.1.1 Rigid 1-2Sided Demand by Region
 - 6.2.1.2 Standard Multilayer Demand by Region
 - 6.2.1.3 HDI/Microvia/Build-Up Demand by Region
 - 6.2.1.4 IC Substrate Demand by Region
 - 6.2.1.5 Flexible Circuits Demand by Region
 - 6.2.1.6 Rigid Flex Demand by Region
 - 6.2.1.7 Others Demand by Region
 - 6.2.2 Demand by Application
 - 6.2.2.1 Consumer electronics Demand by Region
 - 6.2.2.2 Computer Demand by Region
 - 6.2.2.3 Communications Demand by Region
 - 6.2.2.4 Industrial/Medical Demand by Region
 - 6.2.2.5 Automotive Demand by Region
 - 6.2.2.6 Military/Aerospace Demand by Region
 - 6.2.2.7 Others Demand by Region

PART 7 MARKET FORECAST (200 USD)

- 7.1 Global Forecast
- 7.2 Forecast by Type
- 7.3 Forecast by Application
- 7.4 Forecast by Region

PART 8 KEY COMPANIES LIST (600 USD)

- 8.1 Nippon Mektron
 - 8.1.2 Company Information
 - 8.1.2 Products & Services
 - 8.1.3 Business Operation
- 8.2 Unimicron
 - 8.2.1 Company Information
 - 8.2.2 Products & Services
 - 8.2.3 Business Operation
- 8.3 SEMCO
 - 8.3.1 Company Information
 - 8.3.2 Products & Services
 - 8.3.3 Business Operation
- 8.4 Young Poong Group
 - 8.4.1 Company Information
 - 8.4.2 Products & Services
 - 8.4.3 Business Operation
- 8.5 Ibiden
 - 8.5.1 Company Information
 - 8.5.2 Products & Services
 - 8.5.3 Business Operation
- 8.6 ZDT
 - 8.6.1 Company Information
 - 8.6.2 Products & Services
 - 8.6.3 Business Operation
- 8.7 Tripod
 - 8.7.1 Company Information
 - 8.7.2 Products & Services
 - 8.7.3 Business Operation
- 8.8 TTM
 - 8.8.1 Company Information
 - 8.8.2 Products & Services
 - 8.8.3 Business Operation
- 8.9 SEI
 - 8.9.1 Company Information
 - 8.9.2 Products & Services
 - 8.9.3 Business Operation
- 8.10 Daeduck Group
 - 8.10.1 Company Information
 - 8.10.2 Products & Services

- 8.10.3 Business Operation
- 8.11 HannStar Board (GBM)
- 8.12 Viasystems
- 8.13 Nanya PCB
- 8.14 CMK Corporation
- 8.15 Shinko Electric Ind
- 8.16 Compeq
- 8.17 AT&S
- 8.18 Kingboard
- 8.19 Ellington
- 8.20 Junda Electronic
- 8.21 CCTC
- 8.22 Redboard
- 8.23 Wuzhou Group
- 8.24 Kinwong
- 8.25 Aoshikang
- 8.26 Shennan Circuits

PART 9 COMPANY COMPETITION (500 USD)

- 9.1 Market by Company
- 9.2 Price & Gross Margin
- 9.3 Competitive Environment for New Entrants
 - 9.3.1 Michael Porter's Five Forces Model
 - 9.3.2 SWOT

PART 10 RESEARCH CONCLUSION (100 USD)

I would like to order

Product name: Global PCB & PCBA Market Status and Outlook 2018-2025

Product link: <https://marketpublishers.com/r/G65565B8CF0EN.html>

Price: US\$ 4,000.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/G65565B8CF0EN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:
Last name:
Email:
Company:
Address:
City:
Zip code:
Country:
Tel:
Fax:
Your message:

****All fields are required**

Customer signature _____

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970